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3.1.16 Adsorption and Wetting Dynamics3.1.17 General Theory of Adsorption Kinetics; 3.1.17.1 Adsorption Kinetics from Micellar Solutions; 3.1.17.2 Experimental Techniques for Studying Adsorption Kinetics; 3.2 Breaking of Aggregates and Agglomerates (Deagglomeration); 3.2.1 Classification of Dispersants; 3.2.2 Assessment and Selection of Dispersants; 3.2.2.1 Adsorption Isotherms; 3.2.3 Measurement of Dispersion and Particle Size Distribution; 3.2.3.1 Optical Microscopy; 3.2.3.2 Electron Microscopy; 3.2.3.3 Confocal Scanning Laser Microscopy (CLSM); 3.2.3.4 Scattering Techniques
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4.2.2 Flocculation of Electrostatically Stabilized Suspensions

Sommario/riassunto

The first modern approach to relate fundamental research to the applied science of colloids, this series bridges academic research and practical applications, thus providing the information vital to both. Written by the very best scientists in their respective disciplines, this volume describes the role of colloids in paints, highlighting the importance of fundamental research in industrial applications.For surface, polymer and physicochemists, materials scientists, and chemical engineers.